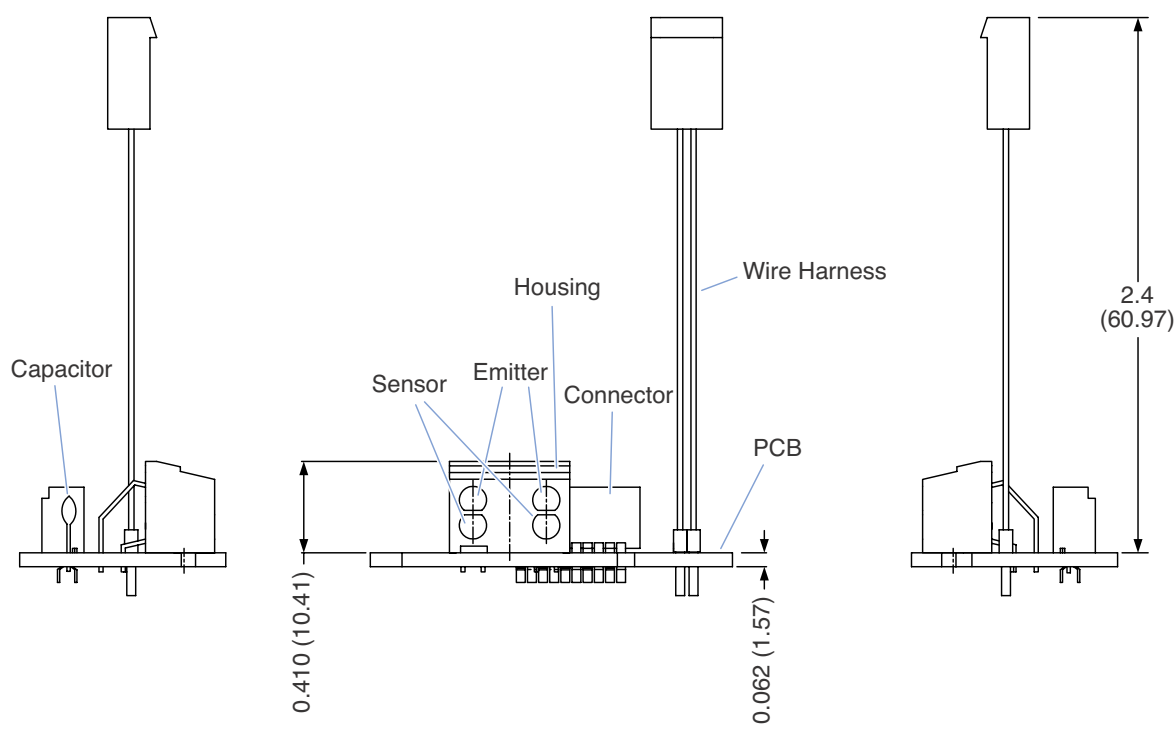
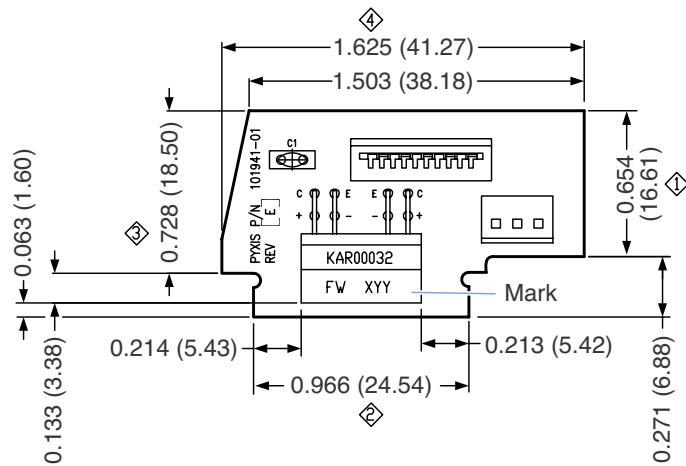


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REVISIONS			
NO.	DESCRIPTION	DATE	NAME/SITE
A	ORIGINATION	10OCTOBER11	—



Dimensions: inches (mm)

**Notes:**

1. Test finished product according to KAR00032 QTID.
2. Mark approximately where shown with FCS part number "KAR00032", FCS logo, assembly plant code (W), and 3 digit date code (year X and week YY). Use white ink, Helvetica or Arial minimum 0.06" high. Laser marking is acceptable.
3. ◊ denotes critical dimension.
4. Reflector, use Kodak paper 90% reflectivity white side, and 10% reflectivity gray side.
5. All exterior surface shall be free of scratches, pits, burrs, and any foreign materials.
6. Full IR device insertion with proper tool that does not stress the leadframe/epoxy interface.
7. Gap between PCB and housing 0.01" maximum.

APPROVALS	DATE	
DRAWN: D. LEISER		
CHECKED: JH. PARK		
APPROVED: T. HERNOLTT		
KAR00032		
PROJECTION	SCALE 1:1	SIZE N/A
	FORMERLY: N/A	DRAWING NUMBER MKT-AC000A
INCH (MM)		REV 0
		SHEET: 1 OF 1